



Product Change Notification

Change Notification #: 115729 - 00
Change Title: Select Intel® SSD 600p Series products,
PCN 115729-00, Transport Media,
Package Update
Date of Publication: August 10, 2017

Key Characteristics of the Change:

Transport Media

Forecasted Key Milestones:

Date Customer Must be Ready to Receive Post-Conversion Material:	Sep 08, 2017
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Description of Change to the Customer:

The Intel® SSD 600p Series SKUs listed in the products affected table below will have the following change.

- The ESD bag and the desiccant are being eliminated as they are not needed.
- A cardboard insert has been modified slightly to allow for easier assembly of the packaging.

Customer Impact of Change and Recommended Action:

The changes to the packaging do not affect the form fit or function of the actual product. This is an FYI to inform customers of the change to the packaging materials.

Milestone dates are estimates and subject to change based on business and operational conditions.

Please contact your local Intel Field Sales Rep if you have any further questions about these changes.

Products Affected / Intel Ordering Codes:

Product Name	Product Code	MM#
Intel® SSD 600p Series (128GB, M.2 80mm PCIe 3.0 x4, 3D1, TLC) Generic 100 Pack	SSDPEKKW128G7X3	954499
Intel® SSD 600p Series (256GB, M.2 80mm PCIe 3.0 x4, 3D1, TLC) Generic 100 Pack	SSDPEKKW256G7X3	954500
Intel® SSD 600p Series (512GB, M.2 80mm PCIe 3.0 x4, 3D1, TLC) Generic 100 Pack	SSDPEKKW512G7X3	954501

PCN Revision History:

Date of Revision:	Revision Number:	Reason:
August 10, 2017	00	Originally Published PCN



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Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below. No response from customers will be deemed as acceptance of the change and the change will be implemented pursuant to the key milestones set forth in this attached PCN.

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